

Technical Data Sheet

February 2002



TX47T2A 2.5 Gbps Cooled Laser DWDM Transmitter Module

Features

- Multisource agreement (MSA) compatible
- Operates at SONET OC-48 rates as well as at ITU-T SDH rates of STM-16
- Wide operating case temperature range : from -15 °C to +75 °C
- High performance MQW distributed feedback laser
- Power supply : + 5.0 V and + 3.3 V
- Clocked or nonclocked operation selectable with single-ended or differential
- ITU-T wavelengths available from 1528.77 nm to 1563.86nm
- Laser back-facet monitor voltage output
- Laser degrade alarm



Applications

- High speed data communication
- Telecommunications
 - ✓ SONET/SDH
 - ✓ metropolitan area networks
 - ✓ wide area networks

Product Code

Product Code	Laser Type	Dipersion Performance
TX47T2A-B35B4	1550 nm cooled DFB-LD	1800 ps/nm(100 km)
TX47T2A-D37B4	1550 nm cooled DFB-LD	3000 ps/nm(170 km)

Description

The TX47T2A 2.5 Gbps cooled laser DWDM transmitter module is designed for use in high speed data communication and telecommunication systems. The transmitter operates at SONET OC-48 rate as well as at ITU-T SDH rate.

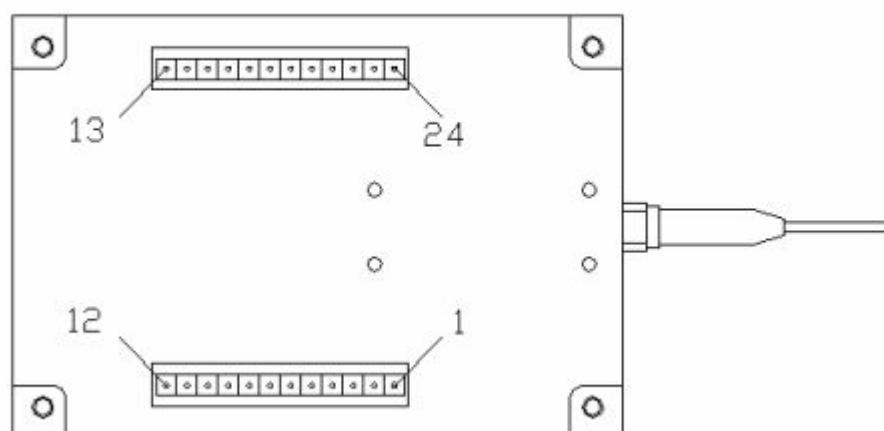
The TX47T2A transmitter meets all GR-253-CORE requirements and the ITU-T G.957 and G.958 recommendations. The transmitter is compatible with the MSA specification, which has a space-saving 24-pin DIP package.

The TX47T2A transmitter incorporates a 1550 nm MQW distributed feedback laser and silicon bipolar laser driver. The transmitter has wide operating case temperature range from -15°C to $+75^{\circ}\text{C}$ with clocked or nonclocked operation and wavelength selection capability.

Pin information

TX47T2A			
Pin	Definition	Pin	Definition
1	Ground (GND_{TEC})	13	Positive Power Supply(V_{CC})
2	Back-facet Monitor(LD_{POWER})	14	TEC Supply Voltage(V_{TEC})
3	Laser Degrade Alarm(LDALM)	15	Ground(GND)
4	Laser Disable(TX DIS)	16	True Data Input(DATA)
5	Clock Selection(CKL SLEC)	17	Ground(GND)
6	Ground (GND)	18	False Data Input(/DATA)
7	Wavelength Deviation Alarm (λ DALM)	19	Ground(GND)
8	Clock I ² C bus (SCL ⁽¹⁾)	20	True Clock Input(CLOCK)
9	Data I ² C bus (SDA ⁽²⁾)	21	Ground(GND)
10	Wavelength Selection (λ SEL)	22	False Clock Input(/CLOCK)
11	Ground (GND)	23	Ground(GND)
12	No Internal Connection (NIC)	24	Positive Power Supply(V_{CC})

⁽¹⁾⁽²⁾ No user connection. Pins must not be tied to ground or any other circuit.



Module Performance Characteristics

Electrical characteristics					
Parameter	Symbol	Min	Typ	Max	Unit
DC power supply voltage	V _{CC}	4.75	5.0	5.25	V
DC power supply current	I _{CC}		160	250	mA
Power dissipation	P _{DIS}		0.8	1.25	W
Input data/clock voltage swing ⁽¹⁾					
Single-ended input	V _{IN}	150	800	1000	mV _{P-P}
Differential input	V _{IN}	75	400	500	mV _{P-P}
Nonclock/Clock selection voltage ⁽²⁾					
Clocked operation	V _{SEL-CLK}	0		1	V
Nonclocked operation	V _{DIS-CLK}	2		Vcc	V
Tx disable voltage ⁽³⁾	V _{DIS}	2		Vcc	V
Tx enable voltage	V _{EN}	0		0.8	V
Wavelength (λ_N) selection voltage	V _{λ_N}	0		0.8	V
Wavelength (λ_{N-1}) selection voltage	V _{λ_{N-1}}	2		Vcc	V
Wavelength deviation alarm					
Deactive voltage level	V _{NO-λ ALM}	0		0.3	V
Active voltage level	V _{λ ALM}	4.5		Vcc	V
Wavelength deviation setting	λ_{ALM}	-100		100	pm
Laser degrade alarm (Active low)					
Levels V _{OL}	V _{ALM}	0		0.3	V
Levels V _{OH}	V _{NO-λ ALM}	4.5		Vcc	V
Setting	LD _{ALM}		50		mA
Laser back-facet monitor voltage ⁽⁴⁾	V _{BF}		500		mV/mW
Clock duty cycle	C _{DC}	40	50	60	%
TEC voltage	V _{TEC}	3	3.3	3.6	V
TEC current	I _{TEC}		0.6	0.9	A

⁽¹⁾ Internally, AC coupled with 50Ω internal termination. If single-ended input is driven, the unused pin must be terminated in 50Ω.

⁽²⁾ When low(or open) the module operates in the clocked mode.

⁽³⁾ When high, the module operates in the Tx disable mode.

⁽⁴⁾ This voltage is measured from pin 2 to GND.

Optical characteristics					
Parameter	Symbol	Min	Typ	Max	Unit
Average optical power output	P _{AVE}		1	+2.0	dBm
Output power variation over temp.	ΔP	-0.5		+0.5	dBm
Center wavelength range	λ _C	1528.77		1563.86	nm
Variation in center wavelength over temperature ⁽¹⁾	Δλ _T	-50		+50	pm
Center Wavelength aging ⁽²⁾	-	-50		+50	pm
Wavelength tuning coefficient	Δλ _C /ΔT _{LD}		0.09		nm/°C
Spectral width full width at -3 dB full width at -20 dB	Δλ		0.11 0.3	0.2 0.5	nm nm
Side-mode suppression ratio	SMSR	30			DB
Generated jitter ⁽²⁾	-			0.15	UI _{P-P}
Extinction ratio	ER	8.5			dB
Optical rising/fall time(20%~80%)	t _R /t _F			130	ps
Maximum return loss(optical)	RL			24	dB
Dispersion penalty 1800 ps/nm 3000 ps/nm	DP			2 2	dB dB

⁽¹⁾ At operating case temperature , -15 °C to +75 °C

⁽²⁾ Measurement max value is 0.15UI_{p-p} in a bandwidth form 5kHz ~ 20MHz.

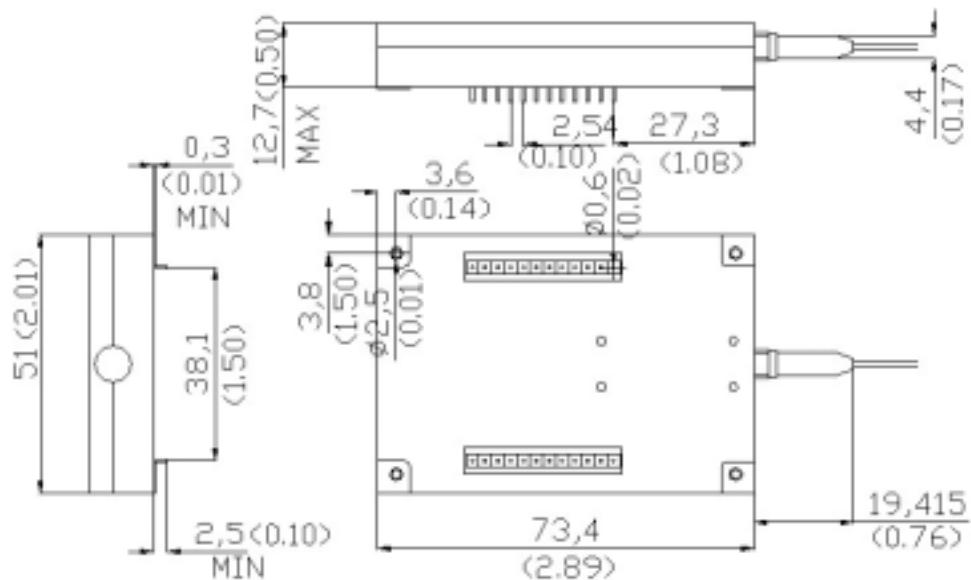
Absolute Maximum Ratings

These are absolute maximum ratings only. Higher stress than these ratings may adversely affect device reliability or cause permanent damage to the device.

Parameter	Unit	Symbol	Min	Max
Supply voltage	V			5.25
TEC voltage	V	V _{TEC}		3.5
Operating case temperature range	°C	T _C	-15	75
Storage case temperature range	°C	T _{STG}	-40	85
Relative humidity	%	RH		85
Lead soldering temperature/time	°C/sec			260/10
Fiber bend radius	mm		30	

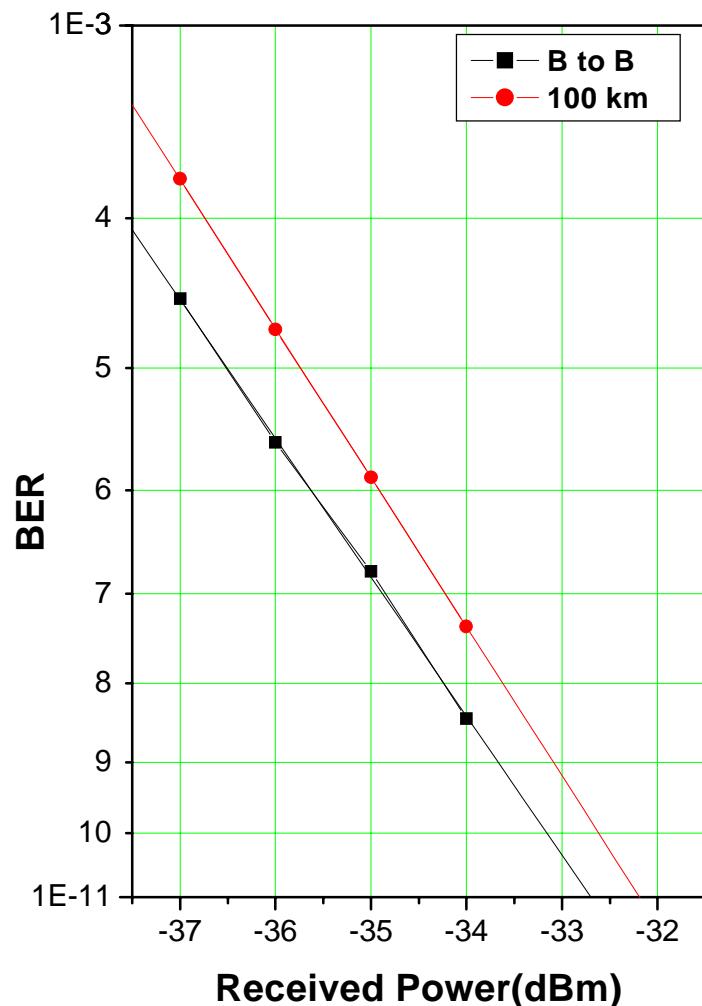
Outline Diagram

Dimensions are in millimeters (inches).

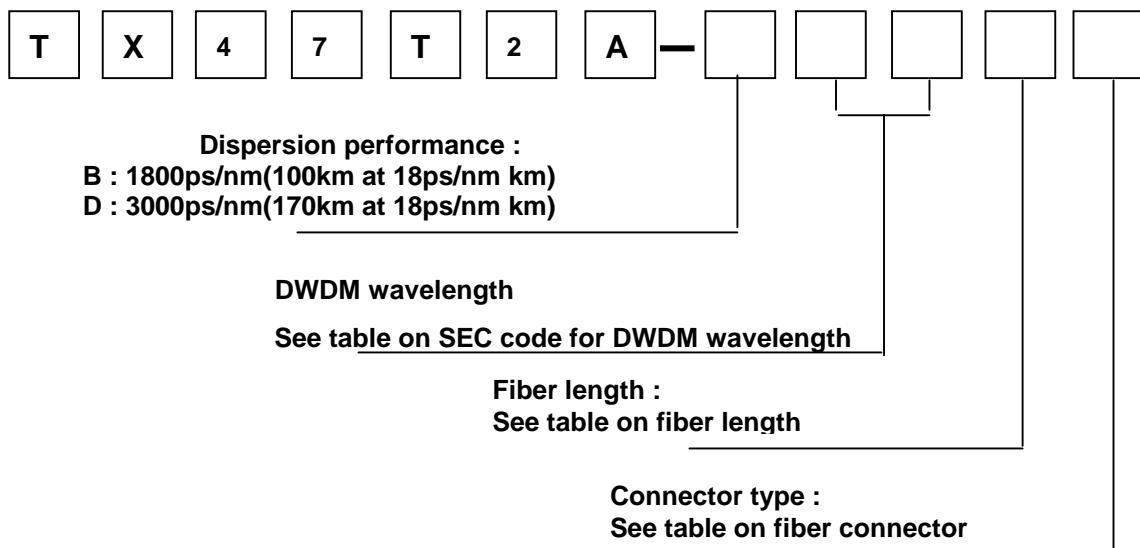


Performance Characteristics

1. BER vs. Received Optical Power



Ordering Information



Dispersion Performance

Code	Dispersion Performance
B	1800ps/nm(100km)
D	3000ps/nm(170km)

Fiber Length

Code	Fiber Length
A	0.5m
B	1.0m
C	1.5m
D	2.0m
E	2.5m

Fiber Connector Type

Code	Connector Type
1	FC/PC
2	FC/APC
3	ST/PC
4	SC/PC
5	Biconic
6	No Connector

SEC Code for DWDM Wavelength

ITU Frequency (THz)	DWDM Wavelength Code	Center Wavelength(nm)	Wavelength Tolerance
191.7	17	1563.86	± 0.4nm
191.8	18	1563.05	± 0.4nm
191.9	19	1562.23	± 0.4nm
192.0	20	1561.42	± 0.4nm
192.1	21	1560.61	± 0.4nm
192.2	22	1559.79	± 0.4nm
192.3	23	1558.98	± 0.4nm
192.4	24	1558.17	± 0.4nm
192.5	25	1557.36	± 0.4nm
192.6	26	1556.55	± 0.4nm
192.7	27	1555.75	± 0.4nm
192.8	28	1554.94	± 0.4nm
192.9	29	1554.13	± 0.4nm
193.0	30	1553.33	± 0.4nm
193.1	31	1552.52	± 0.4nm
193.2	32	1551.72	± 0.4nm
193.3	33	1550.92	± 0.4nm
193.4	34	1550.12	± 0.4nm
193.5	35	1549.32	± 0.4nm
193.6	36	1548.51	± 0.4nm
193.7	37	1547.72	± 0.4nm
193.8	38	1546.92	± 0.4nm
193.9	39	1546.12	± 0.4nm
194.0	40	1545.32	± 0.4nm
194.1	41	1544.53	± 0.4nm
194.2	42	1543.73	± 0.4nm
194.3	43	1542.94	± 0.4nm
194.4	44	1542.14	± 0.4nm
194.5	45	1541.35	± 0.4nm
194.6	46	1540.56	± 0.4nm
194.7	47	1539.77	± 0.4nm
194.8	48	1538.98	± 0.4nm
194.9	49	1538.19	± 0.4nm
195.0	50	1537.40	± 0.4nm
195.1	51	1536.61	± 0.4nm
195.2	52	1535.82	± 0.4nm
195.3	53	1535.04	± 0.4nm
195.4	54	1534.25	± 0.4nm
195.5	55	1533.47	± 0.4nm
195.6	56	1532.68	± 0.4nm
195.7	57	1531.90	± 0.4nm
195.8	58	1531.12	± 0.4nm
195.9	59	1530.33	± 0.4nm
196.0	60	1529.55	± 0.4nm
196.1	61	1528.77	± 0.4nm

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